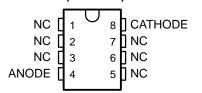
LM285-2.5, LM385-2.5, LM385B-2.5 MICROPOWER VOLTAGE REFERENCES

SLVS023G - JANUARY 1989 - REVISED NOVEMBER 2002

- Operating Current Range . . . 20 μA to 20 mA
- 1.5% and 3% Initial Voltage Tolerance
- Reference Impedance
 - LM385 . . . 1 Ω Max at 25°C
 - All Devices . . . 1.5 Ω Max Over Full Temperature Range
- Very Low Power Consumption
- Applications:
 - Portable Meter References
 - Portable Test Instruments
 - Battery-Operated Systems
 - Current-Loop Instrumentation
 - Panel Meters
- Interchangeable With Industry Standard LM285-2.5 and LM385-2.5

LM285-2.5 . . . D PACKAGE LM385-2.5, LM385B-2.5 . . . D OR PW PACKAGE (TOP VIEW)



NC - No internal connection

LM285-2.5, LM385-2.5, LM385B-2.5 . . . LP PACKAGE (TOP VIEW)



NC - No internal connection

description/ordering information

These micropower two-terminal band-gap voltage references operate over a $20-\mu A$ to 20-m A current range and feature exceptionally low dynamic impedance and good temperature stability. On-chip trimming provides tight voltage tolerance. The band-gap reference for these devices has low noise and long-term stability.

ORDERING INFORMATION

TA	V _Z TOLERANCE	PACKA	GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
	3%	SOIC (D)	Tube of 75	LM385D-2-5	385-25		
0°C to 70°C		Reel of 2000 LM385DR-2-5		LM385DR-2-5	300-20		
		TO 02 (LD)	Tube of 1000	LM385LP-2-5	385-25		
		TO-92 (LP)	Reel of 2000	LM385LPR-2-5	300-20		
		TSSOP (PW)	Tube of 150	LM385PW-2-5	385-25		
			Reel of 2000	LM385PWR-2-5	363-23		
0 0 10 70 0	1.5%	SOIC (D)	Tube of 75	LM385BD-2-5	385B25		
		301C (D)	Reel of 2000	LM385BDR-2-5	303023		
		TO-92 (LP)	Tube of 1000	LM385BLP-2-5	385-25		
		10-92 (LF)	Reel of 2000	LM385BLPR-2-5	363-23		
		TSSOP (PW)	Tube of 150	LM385BPW-2-5	385B25		
		13301 (1 11)	Reel of 2000	LM385BPWR-2-5	303B23		
	1.5%	SOIC (D)	Tube of 75	LM285D-2-5	285-25		
–40°C to 85°C		3010 (b)	Reel of 2000	LM285DR-2-5	200-20		
-40 C 10 65 C		TO-92 (LP)	Tube of 1000	LM285LP-2-5	285-25		
		10 02 (E1)	Reel of 2000	LM285LPR-2-5	285-25		

TPackage drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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description/ordering information (continued)

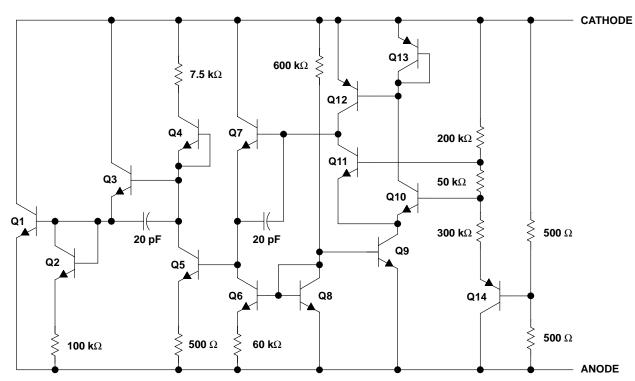
The design makes these devices exceptionally tolerant of capacitive loading and, thus, easier to use in most reference applications. The wide dynamic operating temperature range accommodates varying current supplies, with excellent regulation.

The extremely low power drain of this series makes them useful for micropower circuitry. These voltage references can be used to make portable meters, regulators, or general-purpose analog circuitry, with battery life approaching shelf life. The wide operating current range allows them to replace older references with tighter-tolerance parts.

symbol



schematic



NOTE A: All component values shown are nominal.

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absolute maximum ratings over operating free-air temperature range

Reverse current, I _R		
Forward current, I _F		
Package thermal impedance, θ_{JA} (see Notes 1 and 2)): D package	97°C/W
-	LP package	
	PW package	
Lead temperature 1,6 mm (1/16 inch) from case for 10	0 seconds	260°C
Storage temperature range, T _{sta}		

recommended operating conditions

	MIN	MAX	UNIT		
ΙZ	I _Z Reference current				mA
TA	Operating free-air temperature range	LM285-2.5	-40	85	°C
		LM385-2.5, LM385B-2.5	0 70		

electrical characteristics at specified free-air temperature

PARAMETER		TEST	_ + LM285-2.5			LM385-2.5			LM385B-2.5					
		CONDITIONS	T _A ‡	MIN	TYP	MAX	MIN	TYP	MAX	MIN	TYP	MAX	UNIT	
٧z	Reference voltage	I _Z = 20 μA to 20 mA	25°C	2.462	2.5	2.538	2.425	2.5	2.575	2.462	2.5	2.538	V	
ανΖ	Average temperature coefficient of reference voltage§	I _Z = 20 μA to 20 mA	25°C		±20			±20			±20		ppm/°C	
ΔVZ	Change in reference voltage with current	Change in	I _Z = 20 μA	25°C			1			2			2	
		to 1 mA	Full range			1.5			2			2	mV	
		$=$ $1/$ $=$ 1 μ χ	25°C			10			20			20	TIIV	
			Full range			30			30			30		
ΔV <u>Z</u> /Δt	Long-term change in reference voltage	I _Z = 100 μA	25°C		±20			±20			±20		ppm/khr	
I _{Z(min)}	Minimum reference current		Full range		8	20		8	20		8	20	μΑ	
z _Z	Reference impedance	I= - 400 · · A	25°C		0.2	0.6		0.4	1		0.4	1	Ω	
		$I_Z = 100 \mu\text{A}$	Full range			1.5			1.5			1.5		
V _n	Broadband noise voltage	I _Z = 100 μA, f = 10 Hz to 10 kHz	25°C		120			120			120		μV	

[‡] Full range is 0°C to 70°C for the LM385-2.5 and LM385B-2.5, and -40°C to 85°C for the LM285-2.5.

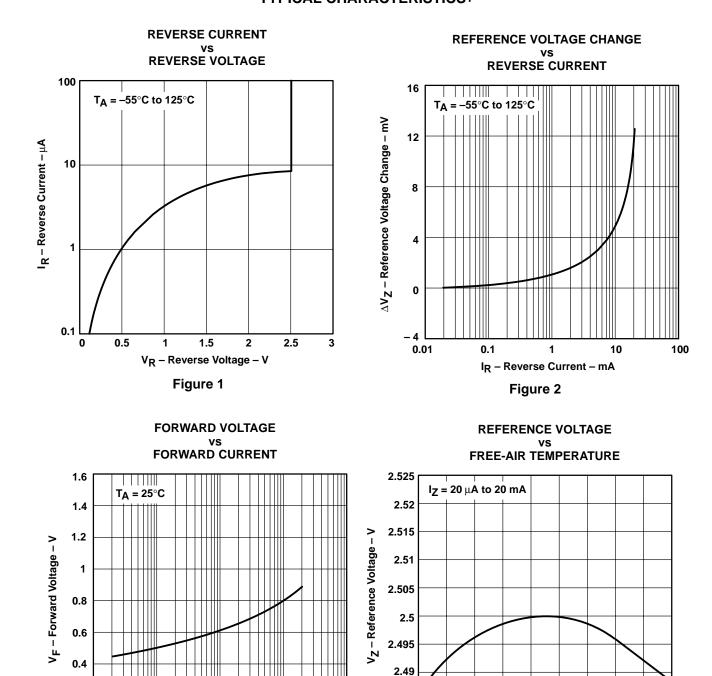
[§] The average temperature coefficient of reference voltage is defined as the total change in reference voltage divided by the specified temperature range.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. Maximum power dissipation is a function of $T_{J(max)}$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_{J(max)} - T_A)/\theta_{JA}$. Operation at the absolute maximum T_J of 150°C can affect reliability. 2. The package thermal impedance is calculated in accordance with JESD 51-7.

TYPICAL CHARACTERISTICS[†]



†Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

100



2.485

-55 - 35 - 15

5

25

Figure 4

T_A - Free-Air Temperature - °C

45

65

85

105 125

0.2

0.01

0.1

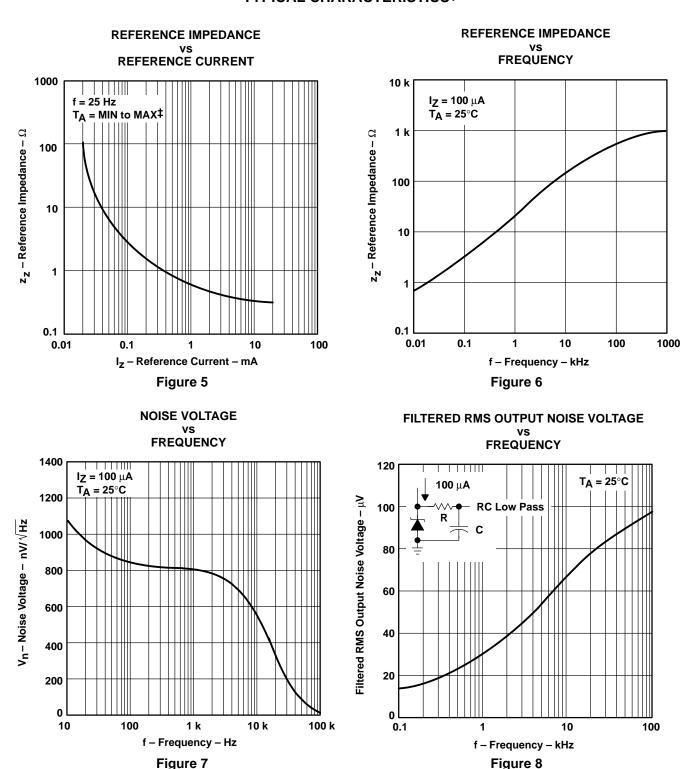
1

IF - Forward Current - mA

Figure 3

10

TYPICAL CHARACTERISTICS[†]



[†]Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



TYPICAL CHARACTERISTICS[†]

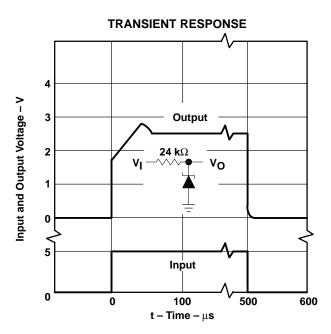
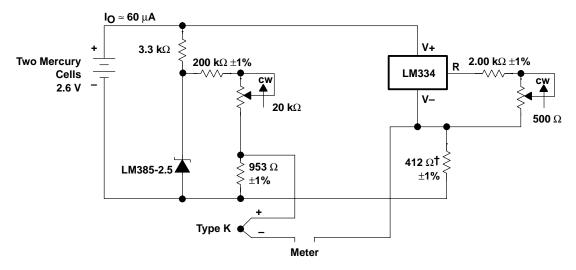


Figure 9

†Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



APPLICATION INFORMATION



[†]Adjust for 12.17 mV at 25°C across 412 Ω

Figure 10. Thermocouple Cold-Junction Compensator

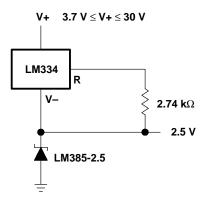


Figure 11. Operation Over a Wide Supply Range

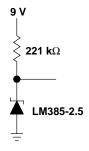
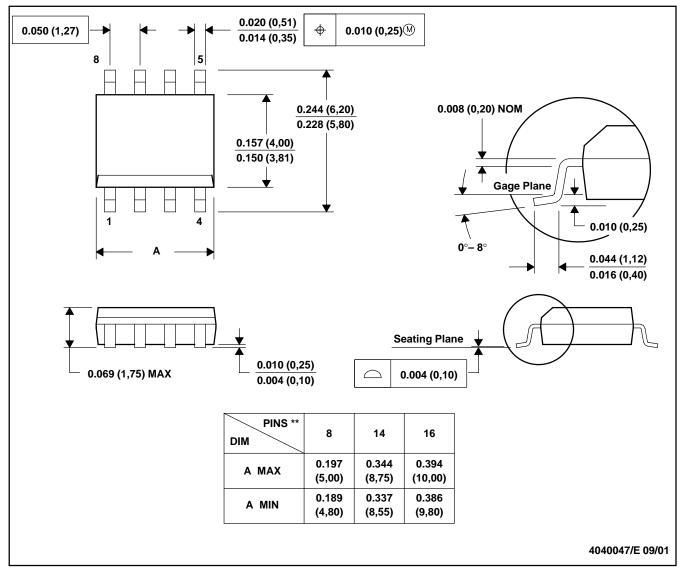


Figure 12. Reference From a 9-V Battery

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

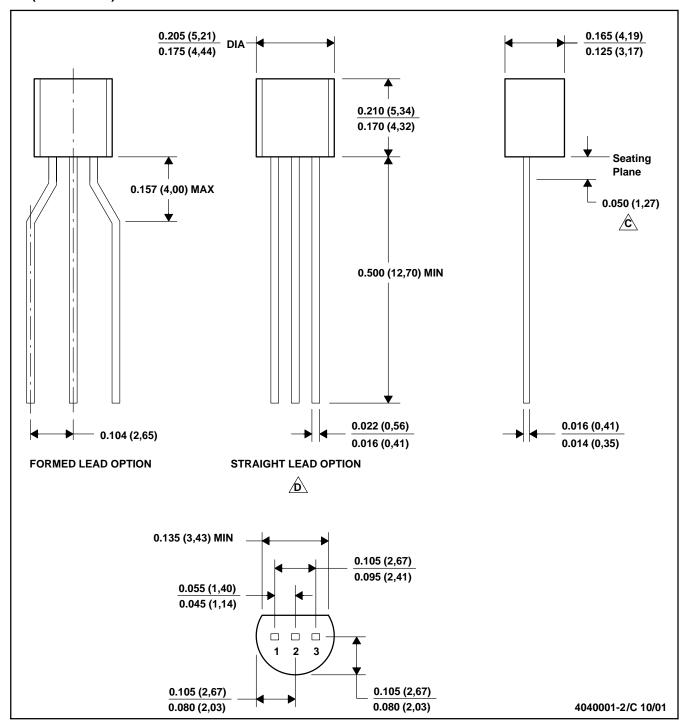
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice. $\hfill \hfill \$

C.\ Lead dimensions are not controlled within this area

D. FAlls within JEDEC TO -226 Variation AA (TO-226 replaces TO-92)

E. Shipping Method:

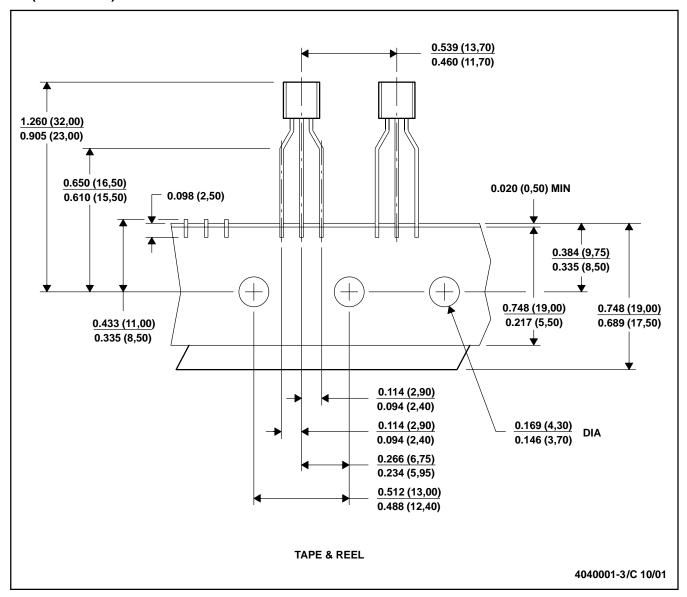
Straight lead option available in bulk pack only.

Formed lead option available in tape & reel or ammo pack.



LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

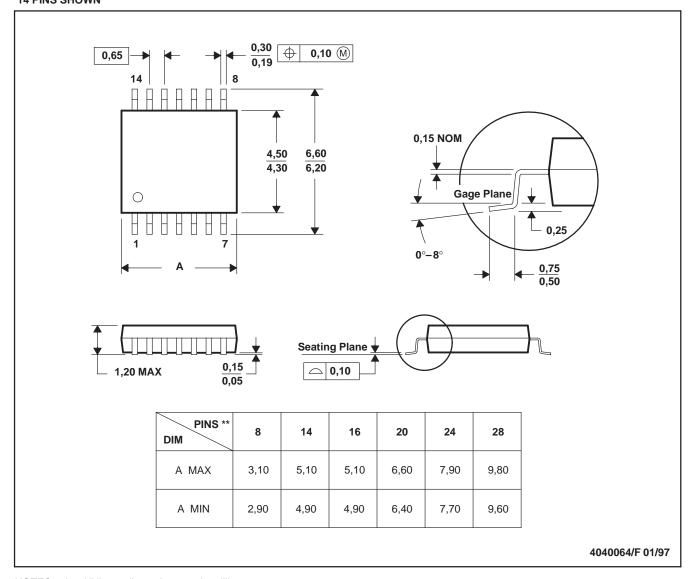
B. This drawing is subject to change without notice.

C. Tape and Reel information for the Format Lead Option package.

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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